

40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI8080-5

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Tc = +25°C
40V	0.7mΩ @ V _{GS} = 10V	460A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

PowerDI8080-5

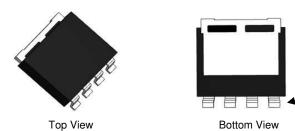
- Engine management systems
- · Body control electronics
- DC-DC converters

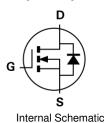
Features and Benefits Rated to +175°C – Ideal for His

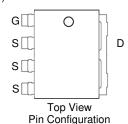
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)}—Minimizes Power Losses
- Wettable Flank for Improved Optical Inspection
- Fast Switching Speed
- Low Input Capacitance
- Lead-Free Finish: RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMTH4M70SPGWQ)

Mechanical Data

- Package: PowerDI[®]8080-5
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish—Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)







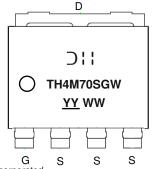
Ordering Information (Note 4)

	Part Number	Dookogo	Packing		
		Раскаде	Qty.	Carrier	
	DMTH4M70SPGW-13	PowerDI8080-5	2000	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



⊃¦¦= Manufacturer's Marking TH4M70SGW = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 22 = 2022) WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	40	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Note 6)	T _C = +25°C	ID	460	Α
Continuous Drain Gurrent (Note 6)	$T_{C} = +100^{\circ}C$		325	
Maximum Continuous Body Diode Forward Current (Note 6)		Is	460	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	1840	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	Ism	1840	Α	
Avalanche Current, L = 1mH		las	43	Α
Avalanche Energy, L = 1mH		Eas	924.5	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5) $T_A = +25^{\circ}C$		PD	5.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Rөja	27	°C/W	
Total Power Dissipation (Note 6)	PD	428	W	
Thermal Resistance, Junction to Case (Note 6)		Rejc	0.35	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

					-		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	40	_		V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS		_	1	μΑ	$V_{DS} = 32V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	1	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	٧	$V_{DS}=V_{GS},\ I_D=250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)	1	0.54	0.7	mΩ	$V_{GS} = 10V, I_{D} = 25A$	
Diode Forward Voltage	V_{SD}		0.7	1.2	٧	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		10053			V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		5786		pF		
Reverse Transfer Capacitance	Crss		116				
Gate Resistance	R_g		2.0		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	1	117.1			V _{DD} = 20V, I _D = 25A, V _{GS} = 10V	
Gate-Source Charge	Qgs		37.7		nC		
Gate-Drain Charge	Q_{gd}		10.9			VGS = 10V	
Turn-On Delay Time	td(on)	1	29.8			$V_{DD} = 20V, V_{GS} = 10V,$ $I_D = 25A, R_G = 5\Omega$	
Turn-On Rise Time	t _R		39.7		ns		
Turn-Off Delay Time	tD(OFF)		99.8		115		
Turn-Off Fall Time	tr		49.0				
Body Diode Reverse Recovery Time	trr	_	117.5	_	ns	1 054 1/1 1004/	
Body Diode Reverse Recovery Charge	QRR	_	340.8		nC	- I _F = 25A, di/dt = 100A/μs	

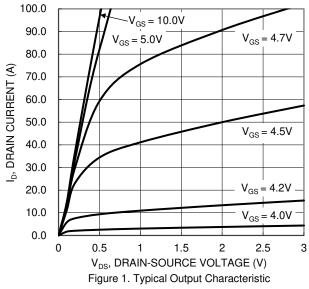
Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.

- 8. Guaranteed by design. Not subject to product testing.







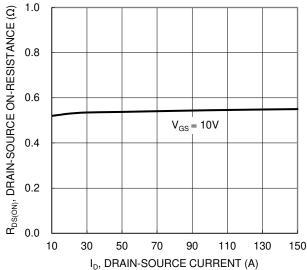


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

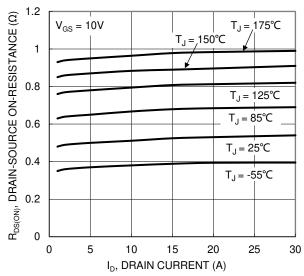
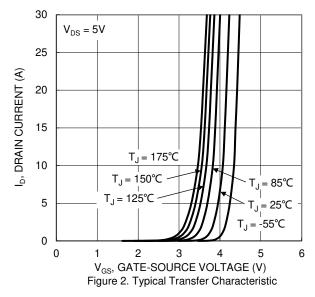
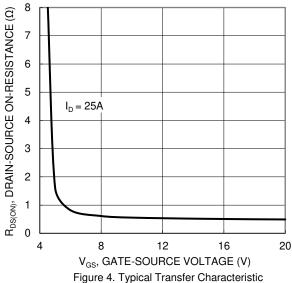


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





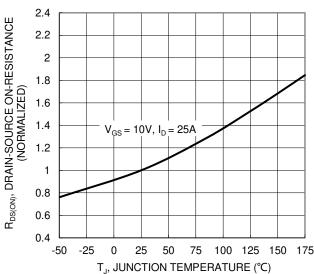


Figure 6. On-Resistance Variation with Junction Temperature





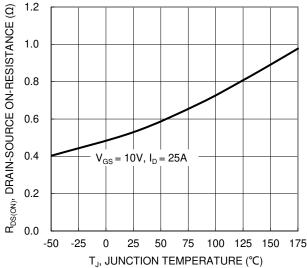
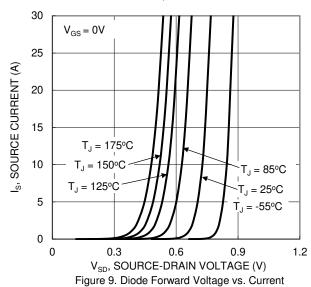
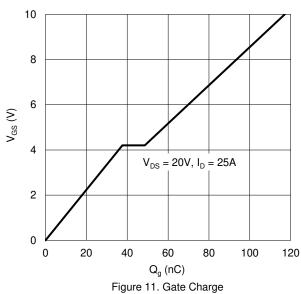
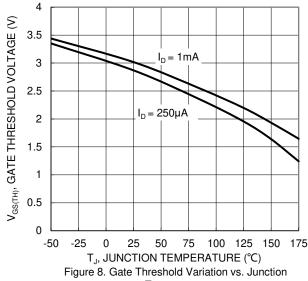


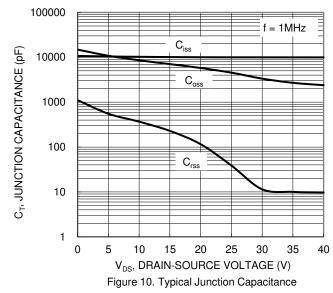
Figure 7. On-Resistance Variation with Junction Temperature







Temperature



10000 $R_{DS(ON)}$ Limited 1000 _D, DRAIN CURRENT (A) 100 10 $P_W = 10ms$ $T_{J(Max)} = 175$ °C $T_C = 25^{\circ}C$ Single Pulse DUT on Infinite Heatsink $V_{GS} = 10V$ 0.1 0.1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



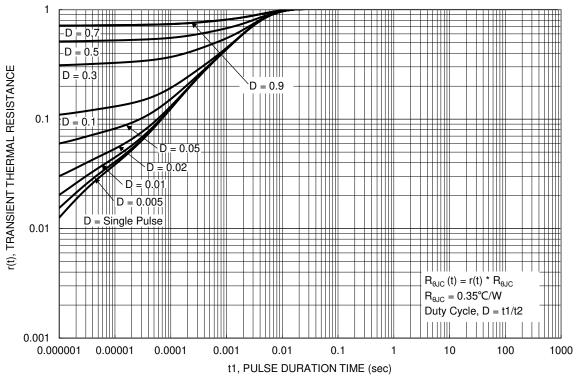


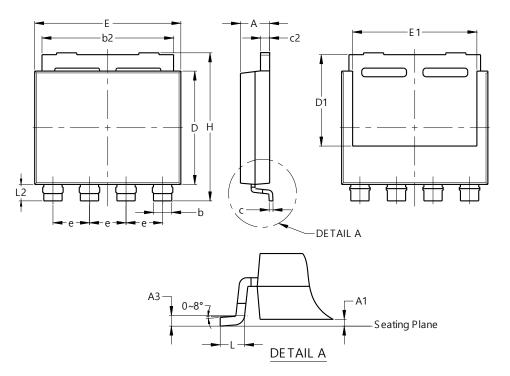
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI8080-5

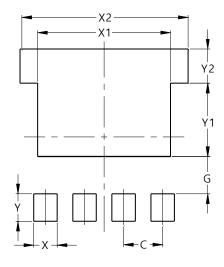


PowerDI8080-5					
Dim	Dim Min		Тур		
Α	1.50	1.70			
A1	0.00	0.15			
A3			0.25		
b	0.90	1.10			
b2	7.10	7.30			
С	0.18	0.24			
c2	0.47	0.57			
D	6.10	6.30			
D1	4.90	5.10			
E	7.90	8.10			
E1	6.70	6.90			
е			2.00		
Н	7.80	8.10			
L	0.60	0.80			
L2	0.90	1.30			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI8080-5



Dimensions	Value		
Dillicusions	(in mm)		
С	2.00		
G	1.90		
Х	1.20		
X1	6.80		
X2	8.60		
Υ	1.40		
Y1	3.74		
Y2	1.76		



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